

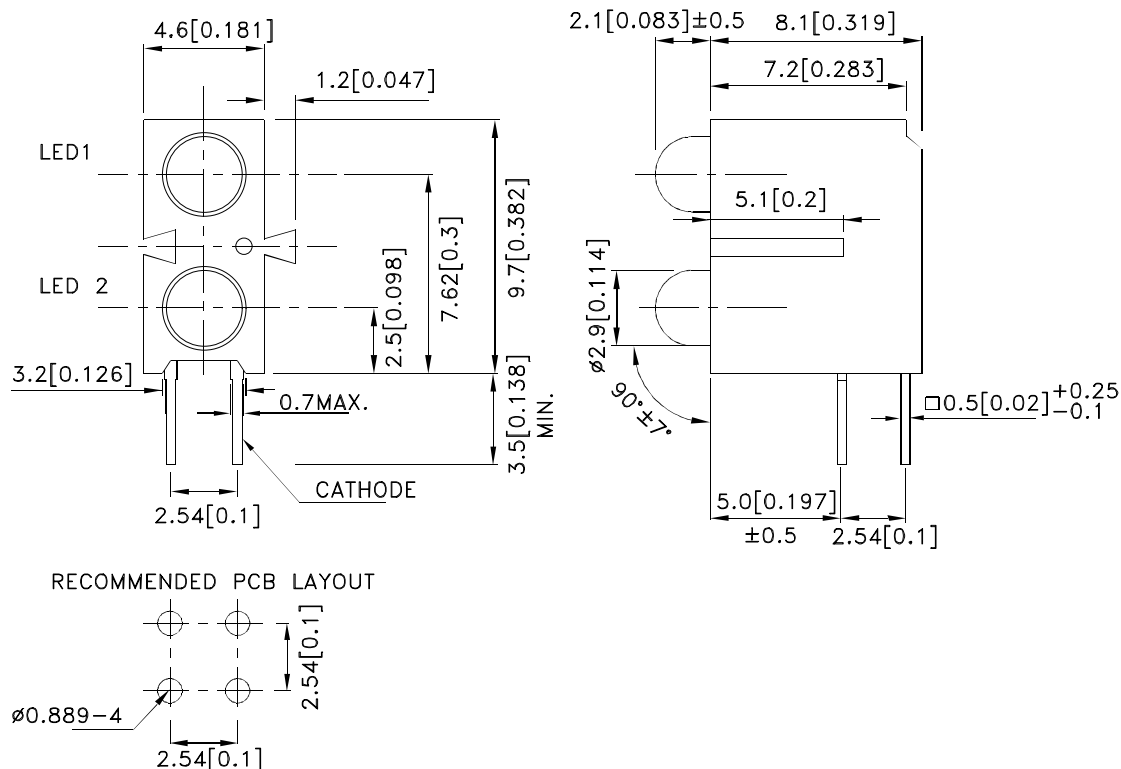
Features

- Pre-trimmed leads for pc mounting.
- Black case enhances contrast ratio.
- Wide viewing angle.
- High reliability life measured in years.
- Housing UL rating:94V-0.
- Housing material: type 66 nylon.
- RoHS compliant.

Description

The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25 (0.01")$ unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.



Selection Guide

| Part No. | Dice | Lens Type | Iv (mcd) [2] @ 10mA | | Viewing Angle [1] |
|----------------|--------------------|-----------------|------------------------|------|----------------------|
| | | | Min. | Typ. | 2θ1/2 |
| WP934CA/2YD-90 | Yellow (GaAsP/GaP) | Yellow Diffused | 8 | 15 | 40° |

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.
3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Typ. | Max. | Units | Test Conditions |
|--------|--------------------------|--------|------|------|-------|-----------------|
| λpeak | Peak Wavelength | Yellow | 590 | | nm | IF=20mA |
| λD [1] | Dominant Wavelength | Yellow | 588 | | nm | IF=20mA |
| Δλ1/2 | Spectral Line Half-width | Yellow | 35 | | nm | IF=20mA |
| C | Capacitance | Yellow | 20 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Yellow | 2.1 | 2.5 | V | IF=20mA |
| IR | Reverse Current | Yellow | | 10 | uA | VR = 5V |

Notes:

1. Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.
3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

| Parameter | Yellow | Units |
|-------------------------------|---------------------|-------|
| Power dissipation | 75 | mW |
| DC Forward Current | 30 | mA |
| Peak Forward Current [1] | 140 | mA |
| Reverse Voltage | 5 | V |
| Operating/Storage Temperature | -40°C To +85°C | |
| Lead Solder Temperature [2] | 260°C For 3 Seconds | |
| Lead Solder Temperature [3] | 260°C For 5 Seconds | |

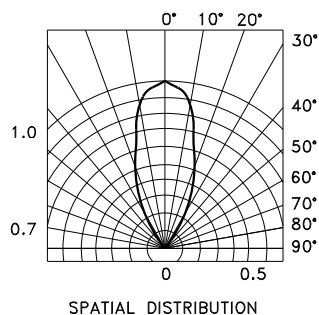
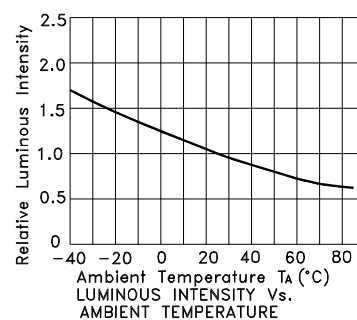
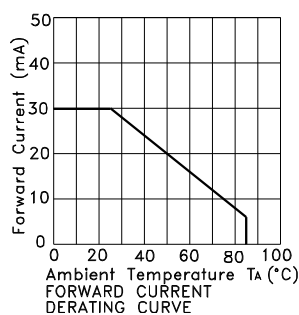
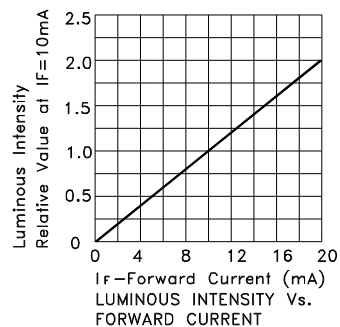
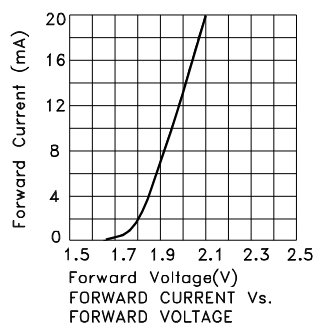
Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.
3. 5mm below package base.



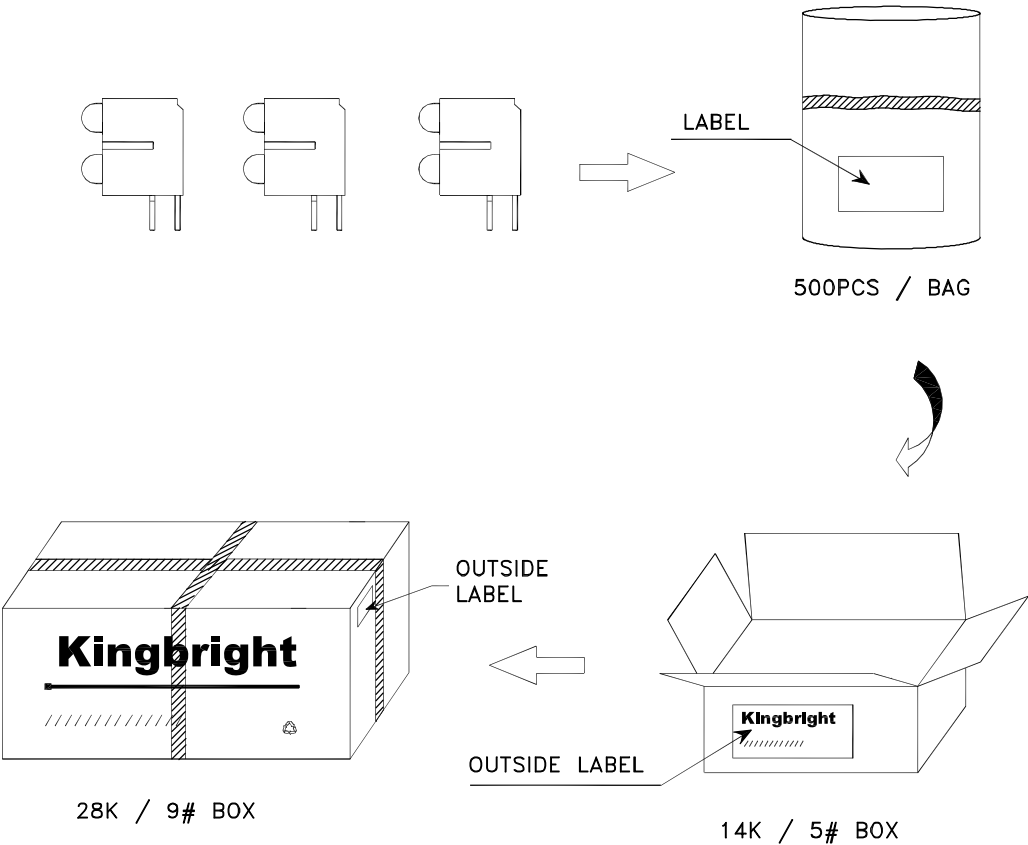
Yellow


WP934CA/2YD-90



PACKING & LABEL SPECIFICATIONS

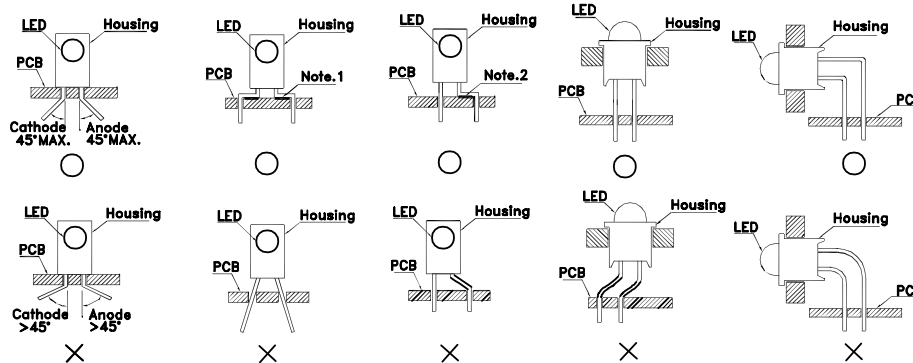
WP934CA/2YD-90



| | | |
|--|------|-----------------------------|
| Kingbright | | |
| P/N0:WP934CAxxx | | |
| QTY: 500 pcs | Q.C. | Q C xx xx xxxx PASSED |
| S/N: XXXX | | |
| CODE: XXX | | |
| LOT NO: | | |
|  xxxxxxxxxxxxxxxxxxxxxxxxxxxx | | |
| RoHS Compliant | | |

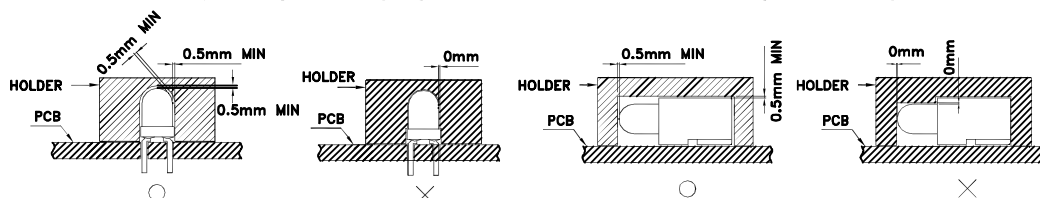
PRECAUTIONS

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.

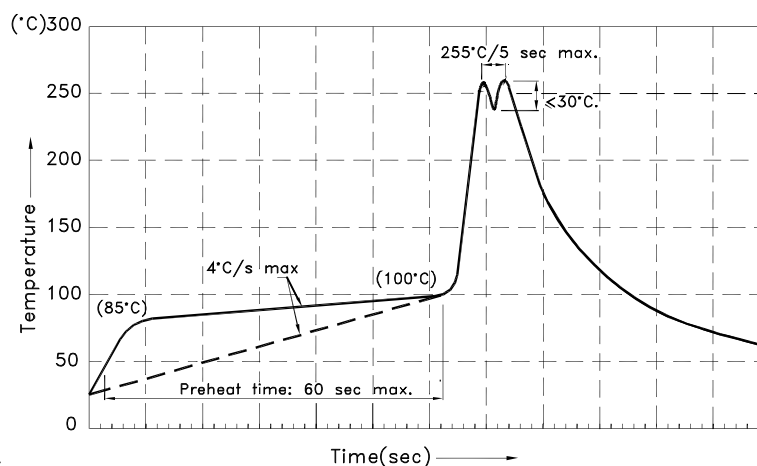


"O" Correct mounting method "X" Incorrect mounting method

2. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.



3. The tip of the soldering iron should never touch the lens epoxy.
4. Through-hole LEDs are incompatible with reflow soldering.
5. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
6. Recommended Wave Soldering Profiles:



Notes:

1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
3. Do not apply stress to the epoxy resin while the temperature is above 85°C.
4. Fixtures should not incur stress on the component when mounting and during soldering process.
5. SAC 305 solder alloy is recommended.
6. No more than one wave soldering pass.

All design applications should refer to Kingbright application notes available at <http://www.KingbrightUSA.com/ApplicationNotes>